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(54) STORAGE CONTAINER, PROCESSING APPARATUS, BONDING APPARATUS, PROCESSING METHOD, AND BONDING **METHOD**

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(57)ABSTRACT

A storage container for storing a die includes a main body including a first through hole and a second through hole, a first lid that is attachable to the main body to cover the first through hole, and a second lid that is attachable to the main body to cover the second through hole. The die is removed/ inserted from/into the main body via the first through hole, and the second through hole is configured to process the die via the second through hole.

